IGBT - Shorted-anode

1500 V, 30 A

FGH30S150P

Description

Using advanced field stop trench and shorted-anode technology, ON Semiconductor's shorted-anode trench IGBTs offer superior conduction and switching performances for soft switching applications. The device can operate in parallel configuration with exceptional avalanche capability. This device is designed for induction heating and microwave oven.

Features

- High Speed Switching
- Low Saturation Voltage: V_{CE(sat)} =1.85 V @ I_C = 30 A
- High Input Impedance
- This Device is Pb-Free and is RoHS Compliant

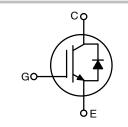
Applications

• Induction Heating, Microwave Oven



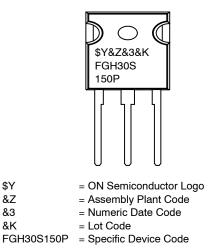
ON Semiconductor®

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MARKING DIAGRAM



ORDERING INFORMATION

See detailed ordering and shipping information in the package dimensions section on page 2 of this data sheet.

ABSOLUTE MAXIMUM RATINGS (T_C = 25°C unless otherwise noted)

Descript	Symbol	Rating	Unit	
Collector to Emitter Voltage Gate to Emitter Voltage		V _{CES}	1500	V
		V _{GES}	±25	V
Collector Current $T_{C} = 25^{\circ}C$		Ιc	60	А
Collector Current	ent $T_{\rm C} = 100^{\circ}{\rm C}$		30	А
Pulsed Collector Current		I _{CM} (Note 1)	90	А
Diode Continuous Forward Current	$T_{C} = 25^{\circ}C$	l _F	60	А
Diode Continuous Forward Current	T _C = 100°C	┨ ┣	30	А
Maximum Power Dissipation	T _C = 25°C	PD	500	W
Maximum Power Dissipation $T_{C} = 100^{\circ}C$		┨ ┣	250	W
Operating Junction Temperature		TJ	-55 to +175	°C
Storage Temperature Range		T _{stg}	-55 to +175	°C
Maximum Lead Temp. for soldering Purpos	TL	300	°C	

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

1. Limited by Tjmax.

THERMAL CHARACTERISTICS

Parameter	Symbol	Тур	Max	Unit
Thermal Resistance, Junction to Case, Max	$R_{\theta JC}$ (IGBT)	-	0.3	°C/W
Thermal Resistance, Junction to Ambient, Max	$R_{\theta JA}$	-	40	°C/W

PACKAGE MARKING AND ORDERING INFORMATION

Part Number	Top Mark	Package	Reel Size	Tape Width	Quantity
FGH30S150P	FGH30S150P	TO-247	-	-	30

ELECTRICAL CHARACTERISTICS OF THE IGBT (T_C = 25°C unless otherwise noted)

Parameter	Symbol	Test Conditions	Min	Тур	Max	Unit		
OFF CHARACTERISTICS								
Collector to Emitter Breakdown Voltage	BV _{CES}	V_{GE} = 0 V, I _C = 1 mA	1500	-	-	V		
Temperature Coefficient of Breakdown Voltage	$\Delta BV_{CES}/\Delta T_{J}$	$V_{GE} = 0 V, I_C = 1 mA$	-	1.5	-	V/°C		
Collector Cut-Off Current	I _{CES}	V _{CE} = 1500, V _{GE} = 0 V	-	-	1	mA		
G-E Leakage Current	I _{GES}	$V_{GE} = V_{GES}, V_{CE} = 0 V$	-	-	±500	nA		

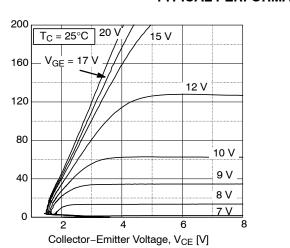
ON CHARACTERISTICs

G-E Threshold Voltage	V _{GE(th)}	$I_C = 30 \text{ mA}, V_{CE} = V_{GE}$	4.5	6.0	7.5	V
Collector to Emitter Saturation Voltage	V _{CE(sat)}	I_{C} = 30 A, V_{GE} = 15 V, T_{C} = 25°C	-	1.85	2.4	V
		I_{C} = 30 A, V_{GE} = 15 V, T_{C} = 125°C	-	2.06	-	V
		I_{C} = 30 A, V_{GE} = 15 V, T_{C} = 175°C	-	2.15	-	V
Diode Forward Voltage	V _{FM}	$I_{F} = 30 \text{ A}, \text{ T}_{C} = 25^{\circ}\text{C}$	-	1.61	2.2	V
		I _F = 30 A, T _C = 175°C	-	1.96	-	V

ELECTRICAL CHARACTERISTICS OF THE IGB1	$(T_{\rm C} = 25^{\circ}{\rm C} \text{ unless otherwise noted})$ (continued)
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Parameter	Symbol	Test Conditions	Min	Тур	Max	Unit
DYNAMIC CHARACTERISTICS		_	•			
Input Capacitance	C _{ies}	V_{CE} = 30 V, V_{GE} = 0 V, f = 1 MHz	-	3310	-	pF
Output Capacitance	C _{oes}		-	70	-	pF
Reverse Transfer Capacitance	C _{res}	-	-	55	-	pF
SWITCHING CHARACTERISTICS						
Turn-On Delay Time	t _{d(on)}	$V_{\rm CC} = 600 \text{ V}, I_{\rm C} = 30 \text{ A},$	-	32	-	ns
Rise Time	t _r	$R_G = 10 \Omega$, $V_{GE} = 15 V$, Resistive Load, $T_C = 25$ °C	-	292	-	ns
Turn-Off Delay Time	t _{d(off)}		-	492	-	ns
Fall Time	t _f		-	214	-	ns
Turn-On Switching Loss	E _{on}		-	1.16	-	mJ
Turn-Off Switching Loss	E _{off}		-	0.9	-	mJ
Total Switching Loss	E _{ts}			2.06	-	mJ
Turn-On Delay Time	t _{d(on)}	$V_{CC} = 600 V, I_C = 30 A,$ $R_G = 10 \Omega, V_{GE} = 15 V,$ Resistive Load, $T_C = 175^{\circ}C$	-	36	-	ns
Rise Time	t _r		-	336	-	ns
Turn–Off Delay Time	t _{d(off)}		-	560	-	ns
Fall Time	t _f		-	520	-	ns
Turn-On Switching Loss	E _{on}		-	1.39	-	mJ
Turn-Off Switching Loss	E _{off}		-	1.86	-	mJ
Total Switching Loss	E _{ts}		_	3.25	-	mJ
Total Gate Charge	Qg	V _{CE} = 600 V, I _C = 30 A, V _{GE} = 15 V	-	369	-	nC
Gate to Emitter Charge	Q _{ge}		-	23.5	-	nC
Gate to Collector Charge	Q _{gc}		_	199	_	nC

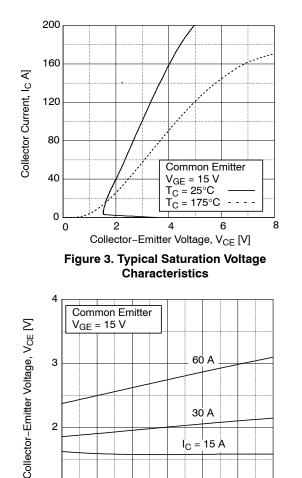
Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.



Collector Current, I_C [A]

TYPICAL PERFORMANCE CHARACTERISTICS





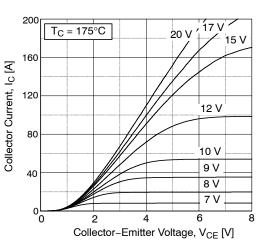


Figure 2. Typical Output Characteristics

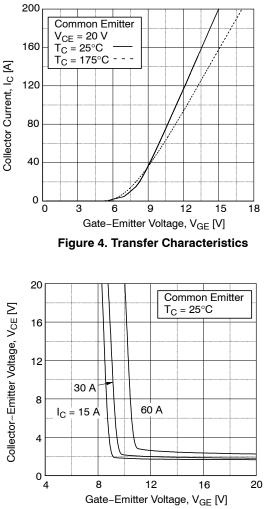


Figure 6. Saturation Voltage vs V_{GE}

Figure 5. Saturation Voltage vs. Case Temperature at Variant Current Level

100

Collector -Emitter Case Temperature, T_C [°C]

1

25

50

75

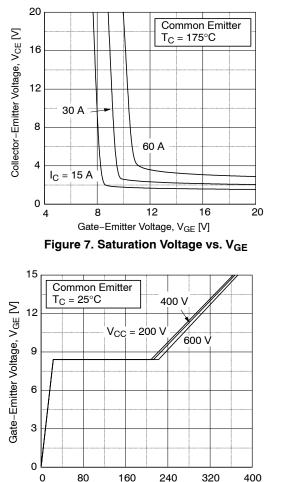
I_C = 15 A

125

150

175

TYPICAL PERFORMANCE CHARACTERISTICS (continued)





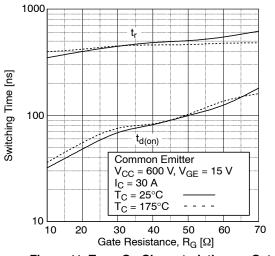


Figure 11. Turn-On Characteristics vs. Gate Resistance

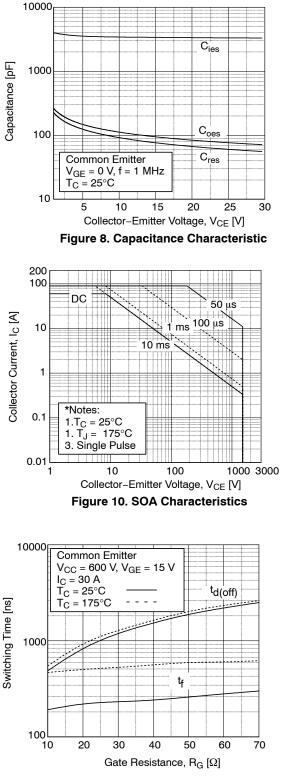
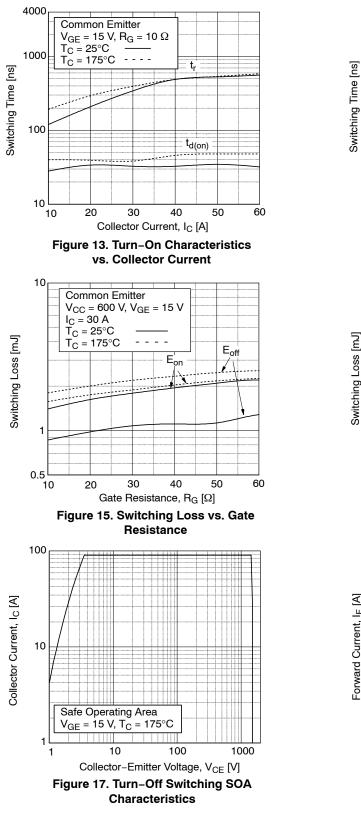
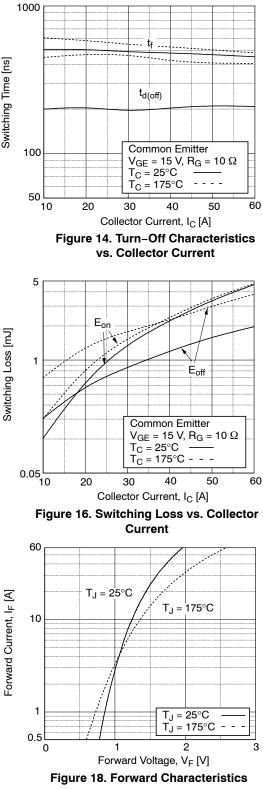


Figure 12. Turn-Off Characteristics vs. Gate Resistance

TYPICAL PERFORMANCE CHARACTERISTICS (continued)





TYPICAL PERFORMANCE CHARACTERISTICS (continued)

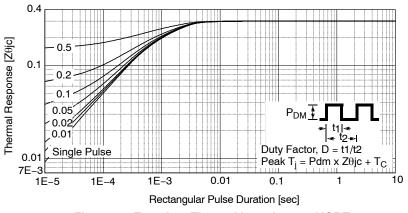
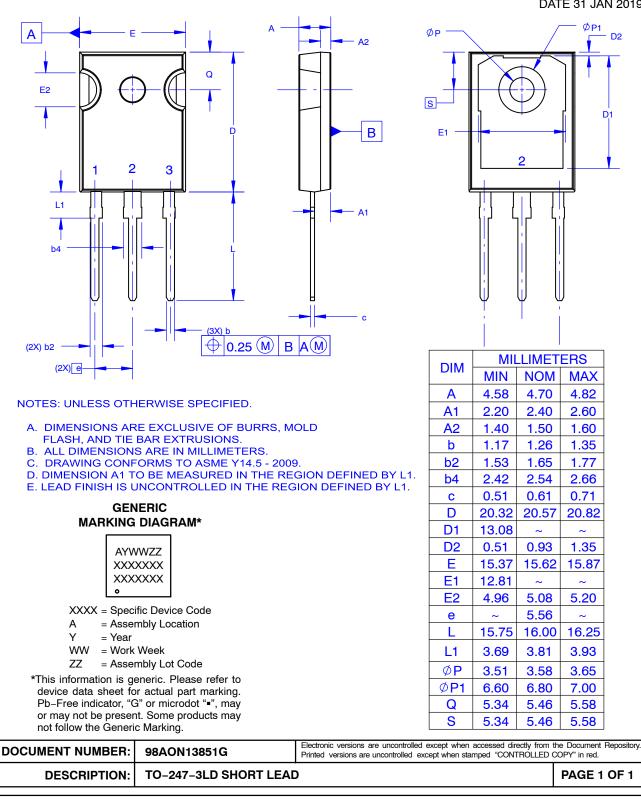


Figure 19. Transient Thermal Impedance of IGBT



TO-247-3LD SHORT LEAD CASE 340CK **ISSUE A**

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